



NOT RECOMMENDED FOR NEW DESIGN CONTACT US

LA431

ADJUSTABLE PRECISION SHUNT REGULATION

General Description

The DIODES[™] LA431 is a low voltage three terminal adjustable shunt regulator with a guaranteed thermal stability over applicable temperature ranges. The output voltage can be set to any value between 2.495V (VREF) to 36V with two external resistors (please refer application circuit). The high precise Reference voltage tolerance is available in two grades: ±0.4% and ±1.0%. This device has a typical minimum cathode current of 0.1 mA. Active output circuitry provides a very sharp turn on characteristic, making this device excellent replacement for Zener diodes in many applications.

Features

- Precision reference voltage :
 - LA431O : 2.495V±0.4%
 - LA431N : 2.495V±1.0%
- Adjustable output voltage is VREF to 36V
- Sink current capability is 120mA
- Low dynamic output impedance is 0.2Ω (typ.)
- Minimum Cathode current for regulation is 0.1mA (typ.)
- Plastic material has UL flammability classification 94V-0.

Applications

- Switching Mode Power Supply
- Voltage Reference Application

Block Diagram & Symbol







LA431

Ordering Information

L	.A 431	X X X	<u>x</u> <u>x</u>	→ Packing → Lead → Pin-out Version → Package Type → Reference Voltage Tol	erance
Reference Voltage Tolerance	Package Type	Pin-out	Version	Lead	Packing
O: ±0.4% N: ±1.0%	H : TO92-3L C : SOT23-3L	Blank (TO92-3L) A (SOT23-3L) R (SOT23-3L)	 REF ANODE CATHODE CATHODE REF ANODE REF CATHODE ANODE 	P : RoHS & Halogen Free (ref. IEC 61249-2-21)	A : Tape & Reel

	÷			
Product Number	Output Voltage Tolerance	Package	Lead	Packing
LA431OHPA	0.4 %	TO92-3L	RoHS& Halogen Free	Taping
LA431NHPA	1.0 %	TO92-3L	RoHS& Halogen Free	Taping
LA431OCAPA	0.4 %	SOT23-3L	RoHS& Halogen Free	Taping & Reel
LA431NCAPA	1.0 %	SOT23-3L	RoHS& Halogen Free	Taping & Reel
LA431OCRPA	0.4 %	SOT23-3L	RoHS& Halogen Free	Taping & Reel
LA431NCRPA	1.0 %	SOT23-3L	RoHS& Halogen Free	Taping & Reel



LA431

Pin Assignment





SEMICONDUCTOR

LITE-ON

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Absolute Maximum Ratings(at T_A=25°C)

Note: Operate over the "Absolute Maximum Ratings" may cause permanent damage to the device. Exposure to such conditions for extended time may still affect the reliability of the device.

Chara	acteristics	Symbol	Rating	Unit
Cathode Voltage		V _{KA}	40	V
Continuous Cathode Curr	ent	I _{KA}	120	mA
Reference Input Current		I _{REF}	10	mA
Junction Temperature		TJ	150	°C
Storage Temperature		T _{STG}	-40~150	°C
ESD Withstand Voltage: -Human Body Model (HE -Machine Model (MM) Me		V _{ESD}	2000 200	V V
Thermal Resistance (Junction to Case)	SOT23-3L TO92-3L	θjc	110 80	°C/W
Thermal Resistance (Junction to Ambient)	SOT23-3L TO92-3L	θja	350 150	°C/W
Power dissipation	SOT23-3L TO92-3L	PD	285 625	mW
Moisture Sensitivity		MSL	Please refer the MSL label on the bag/carton for detail	IC package

Note1: Ratings apply to ambient temperature at 25°C

Recommended Operating Conditions

Characteristics	Symbol	Min	Мах	Unit
Cathode Voltage	V _{KA}	V _{REF}	36	V
Cathode Current	I _{KA}	0.3	100	mA
Operating Temperature (Operating free-air temperature)	T _A	-40	125	°C



LA431

Electrical Characteristics

(TA=25°C, unless otherwise specified)

Characteristics	Symbol	Conditions		Min	Тур	Max	Unit	
	N	V _{KA} = V _{REF.}		0.4 %	2.485	2.495	2.505	V
Reference Voltage	V_{REF}	I _{ка} = 1mA (Fig	.1)	1.0 %	2.470		2.520	v
Deviation of Reference Input Voltage over full temperature			$V_{KA} = V_{REF}, I_{KA} = 10mA,$ $T_A = -20~85^{\circ}C (Fig.1)$			20	30	mV
Range (*Note 2)	V REF(DEV)	$V_{KA} = V_{REF}, I_{KA} = T_A = -40 \sim 125^{\circ}C$,			25	35	mv
Reference Input Current	I _{REF}	R1 = 10KΩ,R2	= ∞, I _{KA} = 10r	mA (Fig.2)		1.5	3.5	uA
Deviation of Reference Input Current over Temperature (*Note 2)	I _{REF(DEV)}	R1 = 10KΩ,R2 = ∞ , I _{KA} = 10mA T _A = -40~125°C (Fig.2)		1	0.4	1.2	uA	
Ratio of the Change in Reference Voltage to the	ΔV _{ref} /	I _{κA} = 10mA	V _{KA} = 10V	~V _{REF}		-1.2	-2.0	
Change in Cathode Voltage	Change in Cathode ΔV_{KA}				C	-1	-2.0	mV/V
Minimum Cathode Current for Regulation	I _{KA(min)}	V _{KA} = V _{REF} (Fig.1)			0.1	0.3	mA	
Off-state Cathode Current	I _{KA(OFF)}	$V_{KA} = 36V, V_{REF} = 0V$ (Fig.3)			0.1	1	uA	
Dynamic Output Impedance	Z _{KA}	V _{KA} = V _{REF} Frequency ≤ 1KHz (Fig.1)				0.2	0.5	Ω

Note 2 : The speicifications are guaranteed by designed and are not tested when in mass-production.



LA431

Application Circuit





LA431

Typical Characteristics



LA431 Document number: DS43807 Rev. 12 - 3



LA431

Typical Characteristics(Continued)

(1) Small Signal Voltage Amplification Vs Frequency







Test Circuit For Reference Impedance



LA431

Typical Characteristics (Continued)

(3) Pulse Response





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Marking Information (NEW)

Effective Date: 2015/11/1





LA431

Marking Information (OLD)

Before 2015/10/31 (included) production, the marking code of parts were used as below.





LA431

Mechanical Information

(1) Package type: TO92-3L





LA431

Mechanical Information (Continued)

Min	Max
4.30	4.70
0.38	0.55
0.36	0.51
4.30	4.70
3.80	4.20
3.30	3.70
2.44	2.64
1.27	ТҮР
2.20	2.96
18.00	21.00
15.50	16.50
12.70	
2.50	4.50
12.40	13.00
12.50	12.90
6.05	6.65
0.35	0.45
0.15	0.25
17.50	19.00
5.50	6.50
8.50	9.50
-	1.00
-	1.00
	$\begin{array}{c c} 4.30 \\ 0.38 \\ 0.36 \\ 4.30 \\ 3.80 \\ 3.80 \\ 3.30 \\ 2.44 \\ 1.27 \\ 2.20 \\ 18.00 \\ 15.50 \\ 12.70 \\ 2.50 \\ 12.70 \\ 2.50 \\ 12.40 \\ 12.50 \\ 6.05 \\ 0.35 \\ 0.15 \\ 17.50 \\ 5.50 \\ 8.50 \\ - \\ \end{array}$



LA431

Mechanical Information (Continued)

(1) Package type: SOT23-3L



Variations	SOT2	3(A)
Symbol	Min	Max
A	0.900	1.150
Al	-	0.100
A2	0.890	1.100
b	0.300	0.500
с	0.070	0.202
D	2.800	3.040
E	2.100	2.640
E1	1.200	1.400
e	0.950	REF
e1	1.800	2.000
L	0.300	0.500
L1	0.550	REF
L2	0.250	BSC
θ	0°	8°



LA431

MSL (Moisture Sensitive Level) Information

			SOAK REQUIREMENTS					
	FLOOR LIFE				Accelerated Equivalent ¹			
LEVEL	FLOOP			Standard		eV		
						0.30-0.39	CONDITION	
	TIME	CONDITION	TIME (hours)	CONDITION	TIME (hours)	TIME (hours)	CONDITION	
1	Unlimited	≤30 °C /85% RH	168 +5/-0	85 °C /85% RH	NA	NA	NA	
2	1 year	≤30 °C /60% RH	168 +5/-0	85 °C /60% RH	NA	NA	NA	
2a	4 weeks	≤30 °C /60% RH	696 ² +5/-0	30 °C /60% RH	120 -1/+0	168 -1/+0	60 °C/ 60% RH	
3	168 hours	≤30 °C /60% RH	192 ² +5/-0	30 °C /60% RH	40 -1/+0	52 -1/+0	60 °C/ 60% RH	
4	72 hours	≤30 °C /60% RH	96 ² +2/-0	30 °C /60% RH	20 +0.5/-0	24 +0.5/-0	60 °C/ 60% RH	
5	48 hours	≤30 °C /60% RH	72 ² +2/-0	30 °C /60% RH	15 +0.5/-0	20 +0.5/-0	60 °C/ 60% RH	
а	24 hours	≤30 °C /60% RH	48 ² +2/-0	30 °C /60% RH	10 +0.5/-0	13 +0.5/-0	60 °C/ 60% RH	
6	Time on Label (TOL)	≤30 °C /60% RH	TOL	30 °C /60% RH	NA	NA	NA	

IPC/JEDEC J-STD-020D.1 Moisture Sensitivity Levels Table

Note 1: CAUTION - To use the "accelerated equivalent" soak conditions, correlation of damage response (including electrical, after soak and reflow), should be established with the "standard" soak conditions. Alternatively, if the known activation energy for moisture diffusion of the package materials is in the range of 0.40 - 0.48 eV or 0.30 - 0.39 eV, the "accelerated equivalent" may be used. Accelerated soak times may vary due to material properties (e.g. mold compound, encapsulant, etc.). JEDEC document JESD22-A120 provides a method for determining the diffusion coefficient.

Note 2: The standard soak time includes a default value of 24 hours for semiconductor manufacturer's exposure time (MET) between bake and bag and includes the maximum time allowed out of the bag at the distributor's facility. If the actual MET is less than 24 hours the soak time may be reduced. For soak conditions of 30 °C/60% RH, the soak time is reduced by 1 hour for each hour the MET is less than 24 hours. For soak conditions of 60 °C/60% RH, the soak time is reduced by 1 hour for each 5 hours the MET is less than 24 hours. If the actual MET is greater than 24 hours the soak time must be increased. If soak conditions are 30 °C/60% RH, the soak time is increased 1 hour for each hour that the actual MET exceeds 24 hours. If soak conditions are 60 °C/60% RH, the soak time is increased 1 hour for each 5 hours that the actual MET exceeds 24 hours.



LA431

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